AMENDMENT TO RULE COMMITTEE PRINT 117-52 OFFERED BY MS. ESHOO OF CALIFORNIA

Add at the end of subtitle E of title VIII the following:

1	SEC. 8 INCENTIVES FOR PRINTED CIRCUIT BOARD
2	MANUFACTURING.
3	(a) Definitions.—In this section:
4	(1) CIRCUIT BOARD.—The term "circuit board"
5	means a piece of insulating material on which elec-
6	trical components are mounted and interconnected
7	by etched copper foil so patterned as to form a cir-
8	cuit.
9	(2) COVERED ENTITY.—The term "covered en-
10	tity" means a non-profit entity, a private entity, a
11	consortium of private entities, or a consortium of
12	public and private entities with the ability to sub-
13	stantially finance, construct, expand, or modernize a
14	facility relating to manufacturing of printed circuit
15	boards.
16	(3) COVERED PROJECT.—The term "covered
17	project" means—
18	(A) a project the purpose of which is the
19	construction, expansion, or modernization of a

1	facility described in paragraph (2) that will be
2	located in the United States; and
3	(B) a workforce-related project (including
4	an agreement to provide grants for workforce
5	training or vocational education), any conces-
6	sion with respect to real property and any other
7	project determined by the Secretary, in con-
8	sultation with the Secretary of State, to be ap-
9	propriate and related to encouraging investment
10	in facilities and equipment in the United States
11	for manufacturing of printed circuit boards.
12	(4) Economically disadvantaged indi-
13	VIDUAL.—The term "economically disadvantaged in-
14	dividual" means an individual described in section
15	8(a)(6)(A) of the Small Business Act (15 U.S.C
16	637(a)(6)(A)).
17	(5) Foreign entity; foreign entity of
18	CONCERN.—The terms "foreign entity" and "foreign
19	entity of concern" have the meanings given such
20	terms in section 9901 of the William M. (Mac)
21	Thornberry National Defense Authorization Act for
22	Fiscal Year 2021 (Public Law 116–283; 15 U.S.C
23	4651).
24	(6) Historically black college or uni-
25	VERSITY.—The term "historically Black college or

1 university" has the meaning given the term "part B 2 institution" in section 322 of the Higher Education 3 Act of 1965 (20 U.S.C. 1061). 4 (7) Institution of higher education.—The 5 term "institution of higher education" has the 6 meaning given such term in section 101 of the High-7 er Education Act of 1965 (20 U.S.C. 1001). 8 (8) Integrated circuit substrate.—The 9 term "integrated circuit substrate" means the sup-10 porting material upon or within which an integrated 11 circuit is fabricated or to which an integrated circuit 12 is attached. 13 INTELLIGENCE COMMUNITY.—The 14 "intelligence community" has the meaning given 15 that term in section 3 of the National Security Act 16 of 1947 (50 U.S.C. 3003). 17 (10) Minority-owned business and women-18 OWNED BUSINESS.—The terms "minority-owned 19 business" and "women-owned business" have the 20 meanings given such terms in section 704B(h) of the 21 Equal Credit Opportunity Act (15 U.S.C. 1691c-22 2(h)). 23 (11)MINORITY-SERVING INSTITUTION.—The 24 term "minority-serving institution" means any of the following: 25

1	(A) An Alaska Native-serving institution
2	(as that term is defined in section 317(b) of the
3	Higher Education Act of 1965 (20 U.S.C.
4	1059d(b))).
5	(B) A Native Hawaiian-serving institution
6	(as that term is defined in section 317(b) of
7	such Act (20 U.S.C. 1059d(b))).
8	(C) A Predominantly Black institution (as
9	that term is defined in section 371(c) of such
10	Act (20 U.S.C. $1067q(e)$)).
11	(D) An Asian American and Native Amer-
12	ican Pacific Islander-serving institution (as that
13	term is defined in section 320(b) of such Act
14	(20 U.S.C. 1059g(b))).
15	(E) A Native American-serving, nontribal
16	institution (as that term is defined in section
17	319(b) of such Act (20 U.S.C. 1059f(b))).
18	(12) Person.—The term "person" means an
19	individual or entity.
20	(13) Printed Circuit Board.—The term
21	"printed circuit board" means a circuit board on
22	which a pattern of copper foil connecting the compo-
23	nents has been etched or printed, including boards
24	with printed circuits on both sides and boards with
25	printed circuits on one side only, for the mounting

1	of components on which most connections are made
2	by printed circuitry.
3	(14) Program.—The term "Program" means
4	the program established under subsection $(b)(1)$.
5	(15) Secretary.—The term "Secretary"
6	means the Secretary of Commerce.
7	(16) Small Business.—The term "small busi-
8	ness" has the meaning given the term "small busi-
9	ness concern" under section 3(a) of the Small Busi-
10	ness Act (15 U.S.C. 632(a)), except that section
11	121.103 of title 13, Code of Federal Regulations (or
12	any successor regulation) shall not apply.
13	(17) State.—The term "State" means each
14	State of the United States, the District of Columbia,
15	each commonwealth, territory, or possession of the
16	United States, and each federally recognized Indian
17	Tribe.
18	(18) Veteran-owned business.—The term
19	"veteran-owned business" has the meaning given the
20	term "small business concern owned and controlled
21	by veterans" in section 3(q) of the Small Business
22	Act (15 U.S.C. 632(q)).
23	(b) Financial Assistance Program.—
24	(1) IN GENERAL.—The Secretary shall establish
25	a program that, in accordance with the requirements

1	of this section and subject to the availability of ap-
2	propriations for such purposes, provides Federal fi-
3	nancial assistance to covered entities to incentivize
4	investment in facilities and equipment in the United
5	States for manufacturing of printed circuit boards.
6	(2) Procedure.—
7	(A) In general.—A covered entity shall
8	submit to the Secretary an application that de-
9	scribes the project for which the covered entity
10	is seeking financial assistance under the Pro-
11	gram.
12	(B) Eligibility.—Except as provided in
13	subparagraph (C), in order for a covered entity
14	to qualify for financial assistance under the
15	Program, the covered entity shall demonstrate
16	to the Secretary, in the application submitted
17	by the covered entity under subparagraph (A),
18	that—
19	(i) the covered entity has a docu-
20	mented interest in carrying out a covered
21	project; and
22	(ii) with respect to the project de-
23	scribed in clause (i), the covered entity
24	has—

1	(I) a plan the Secretary deter-
2	mines to be executable to sustain the
3	covered project described in clause (i)
4	without additional Federal financial
5	assistance under the Program for fa-
6	cility support;
7	(II) made commitments to work-
8	er and community investment, includ-
9	ing through—
10	(aa) training and education
11	benefits provided by or paid for
12	by the covered entity; and
13	(bb) programs to expand
14	employment opportunity for eco-
15	nomically disadvantaged individ-
16	uals; and
17	(III) secured commitments from
18	regional educational and training enti-
19	ties, postsecondary vocational institu-
20	tions (defined in section 102(c) of the
21	Higher Education Act of 1965 (20
22	U.S.C. 1002(e))), or institutions of
23	higher education to provide workforce
24	training, including programming for

1	training and job placement of eco-
2	nomically disadvantaged individuals.
3	(C) SMALL BUSINESS EXCEPTION.—The
4	requirements in subclauses (II) and (III) of
5	subparagraph (B)(ii) do not apply to small
6	businesses.
7	(D) DUE DILIGENCE.—With respect to the
8	review by the Secretary of an application sub-
9	mitted by a covered entity under subparagraph
10	(A), the Secretary may not approve the applica-
11	tion unless the Secretary—
12	(i) confirms that the covered entity
13	has satisfied the applicable eligibility cri-
14	teria under subparagraph (B); and
15	(ii) determines that the project to
16	which the application relates is in the in-
17	terest of the United States.
18	(E) Considerations for review.——
19	(i) In general.—Except as provided
20	in clause (ii), with respect to the review by
21	the Secretary of an application submitted
22	by a covered entity under subparagraph
23	(A), the Secretary shall consider whether
24	the covered entity has—

1	(I) previously received financial
2	assistance under the Program; and
3	(II) demonstrated that it is re-
4	sponsive to the national security needs
5	or requirements established by the in-
6	telligence community (or an agency
7	thereof), the National Nuclear Secu-
8	rity Administration, or the Depart-
9	ment of Defense.
10	(ii) Small businesses excluded.—
11	Clause (i)(I) does not apply with respect to
12	an application submitted by a small busi-
13	ness under subparagraph (A).
14	(F) Preferences.—The Secretary shall,
15	when practicable, give preference with respect
16	to the approval of an application submitted
17	under subparagraph (A) by a covered entity
18	that—
19	(i) is a small business, minority-owned
20	business, women-owned business, or vet-
21	eran-owned business;
22	(ii) expands the United States produc-
23	tion capacity of integrated circuit sub-
24	strates;

1	(iii) is relocating a manufacturing fa-
2	cility of printed circuit boards currently lo-
3	cated in an area owned by, controlled by,
4	or subject to the jurisdiction or direction of
5	a foreign entity of concern; or
6	(iv) includes a workforce training pro-
7	gram that secures commitments from an
8	institution of higher education that is—
9	(I) a historically Black college or
10	university;
11	(II) a Hispanic-serving institu-
12	tion (as such term is defined in sec-
13	tion 502(a) of the Higher Education
14	Act of 1965 (20 U.S.C. 1101a(a)));
15	(III) a Tribal College or Univer-
16	sity (as such term is defined in sec-
17	tion 316(b) of the Higher Education
18	Act of 1965 (20 U.S.C. 1059e(b)));
19	(IV) a minority-serving institu-
20	tion; or
21	(V) a rural-serving institution of
22	higher education (as such term is de-
23	fined in section 861(b) of the Higher
24	Education Act of 1965 (20 U.S.C.
25	1161q(b))).

1	(G) Foreign entities of concern ex-
2	CLUSION.—
3	(i) The Secretary may not approve an
4	application of a covered entity if the Sec-
5	retary determines that the covered entity is
6	a foreign entity of concern.
7	(ii) None of the funds authorized to
8	be appropriated to carry out this sub-
9	section may be provided to a foreign entity
10	of concern.
11	(H) RECORDS PRODUCTION.—
12	(i) IN GENERAL.—The Secretary may
13	request from a covered entity that submits
14	an application under subparagraph (A) any
15	records and other information that the
16	Secretary determines necessary for the
17	purposes of ascertaining whether an award
18	under the Program will be used for the
19	covered project for which such award is
20	sought, including records or other informa-
21	tion regarding the status of such project.
22	(ii) Funding restriction.—No cov-
23	ered entity that fails to provide records or
24	information requested by the Secretary
25	under this subparagraph shall be eligible

1	for Federal financial assistance under the
2	Program if such records or information are
3	reasonably available to such covered entity.
4	(3) Amount.—The Secretary shall determine
5	the appropriate amount and funding type for each
6	financial assistance award made to a covered entity
7	under the Program.
8	(4) Use of funds.—A covered entity that re-
9	ceives a financial assistance award under the Pro-
10	gram may only use the financial assistance award
11	amounts—
12	(A) for a covered project; and
13	(B) to pay reasonable costs related to the
14	operating expenses for such covered project, in-
15	cluding costs relating to the specialized work-
16	force, essential materials, and complex equip-
17	ment maintenance, as determined by the Sec-
18	retary.
19	(5) Clawback.—
20	(A) DELAY CLAWBACK.—
21	(i) Target dates.—With respect to
22	any award made under the Program, the
23	Secretary shall—
24	(I) determine target dates by
25	which the project with respect to

1	which such award was made shall
2	commence and complete; and
3	(II) set such dates by the time of
4	the award.
5	(ii) Progressive recovery for
6	DELAYS.—If a project is not commenced
7	and completed by the dates determined
8	under clause (i) for such project, the Sec-
9	retary shall progressively recover from the
10	recipient of the award for such project up
11	to the full amount of such award.
12	(iii) Waiver.—In the case of a
13	project that is not commenced or com-
14	pleted by the dates determined under
15	clause (i) for such project, the Secretary
16	may waive elements of the clawback provi-
17	sions incorporated in the award made
18	under the Program for such project only if,
19	prior to granting such waiver, the Sec-
20	retary—
21	(I) makes a formal determination
22	that circumstances beyond the ability
23	of the covered entity to foresee or con-
24	trol are responsible for delays; and
25	(II) submits a notice to Congress.

1	(B) TECHNOLOGY CLAWBACK.—The Sec-
2	retary may recover the full amount of any
3	award made under the Program from the re-
4	cipient of the award if, during the period deter-
5	mined under subparagraph (A)(i) for the
6	project with respect to which such award was
7	made, the recipient knowingly engages in any
8	joint research or technology licensing effort
9	with a foreign entity of concern that relates to
10	a technology or product that raises national se-
11	curity concerns, as determined by the Secretary.
12	(C) Notification to congress.—
13	(i) IN GENERAL.—The Secretary shall
14	notify Congress of—
15	(I) the clawback provisions at-
16	tending each award described in sub-
17	paragraph (A)(i); and
18	(II) each waiver provided under
19	subparagraph (A)(iii) not later than
20	15 days after the date on which the
21	Secretary provides such waiver.
22	(ii) Waiver notice contents.—The
23	notice required under clause (i)(II) shall
24	include—

1	(I) the elements of the clawback
2	provisions that were waived under
3	subparagraph (A)(iii);
4	(II) an explanation of why such
5	waiver was provided;
6	(III) the duration of the delay
7	with respect to which such waiver was
8	granted; and
9	(IV) the name of the covered en-
10	tity that was granted such waiver.
11	(c) Coordination Required.—In carrying out the
12	Program, the Secretary shall coordinate with—
13	(1) the Secretary of State;
14	(2) the Secretary of Defense;
15	(3) the Secretary of Energy;
16	(4) the Director of National Intelligence;
17	(5) the Director of the Minority Business De-
18	velopment Agency of the Department of Commerce;
19	(6) the Administrator of the Small Business
20	Administration;
21	(7) the Director of the National Institute of
22	Standards and Technology;
23	(8) the Director of the Cybersecurity and Infra-
24	structure Agency; and

1	(9) the Director of the Office of Foreign Assets
2	Control of the Department of the Treasury.
3	(d) GAO REVIEWS.—The Comptroller General of the
4	United States shall—
5	(1) not later than 2 years after the date of dis-
6	bursement of the first award under the Program,
7	and biennially thereafter for 10 years, conduct a re-
8	view of the Program, which shall include—
9	(A) a determination of the number of
10	awards provided under the Program during the
11	two-year period immediately preceding the re-
12	view;
13	(B) an evaluation of how—
14	(i) such program is being carried out,
15	including how recipients of awards under
16	the Program are being selected; and
17	(ii) other Federal programs are lever-
18	aged for manufacturing, research, and
19	training to complement the awards made
20	under the Program; and
21	(C) a description of the outcomes of
22	projects supported by awards made under the
23	Program, including a description of—

1	(i) facilities described in subsection
2	(b)(1) that were constructed, expanded, or
3	modernized as a result of such awards;
4	(ii) workforce training programs car-
5	ried out with such awards, including ef-
6	forts to hire economically disadvantaged
7	individuals; and
8	(iii) the effects of such projects on the
9	United States' share of global printed cir-
10	cuit board production; and
11	(2) notify Congress of the results of each review
12	conducted under paragraph (1).
13	(e) Authorization of Appropriations.—There is
14	authorized to be appropriated \$3,000,000,000 for fiscal
15	year 2023, to remain available through fiscal year 2024,
16	to carry out this section.

